

# 0.8A, 50V - 1000V Surface Mount Fast Recovery Rectifiers

## FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Fast switching for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

### **MECHANICAL DATA**

Case: Sub SMA

Molding compound, UL flammability classification rating 94V-0 Moisture sensitivity level: level 1, per J-STD-020 Part No. with suffix "H" means AEC-Q101 qualified Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 2 whisker test **Polarity:** Indicated by cathode band **Weight:** 0.019 g (approximately)







Sub SMA

MAXIMUM RATINGS AND ELECTRICAL CHARA	ACTERISTI	CS (T <sub>A</sub>	=25°C ι	unless c	otherwis	e notec	l)		
PARAMETER	SYMBOL	RS1	RS1	RS1	RS1	RS1	RS1	RS1	UNIT
	STIVIBUL	AL	BL	DL	GL	JL	KL	ML	UNIT
Marking code		RAL	RBL	RDL	RGL	RJL	RKL	RML	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	I <sub>F(AV)</sub>				0.8				Α
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>				30				А
Maximum instantaneous forward voltage (Note 1) @ 0.8 A	V <sub>F</sub>				1.3				V
Maximum reverse current @ rated $V_R$ T <sub>J</sub> =25°C T <sub>J</sub> =125°C	I <sub>R</sub>				5 50				μA
Typical junction capacitance (Note 2)	CJ				10				pF
Maximum reverse recovery time (Note 3)	t <sub>rr</sub>		1:	50		250	50	00	ns
Typical thermal resistance	R <sub>θJL</sub> R <sub>θJA</sub>				32 105				°C/W
Operating junction temperature range	TJ			- :	55 to +1	50			°C
Storage temperature range	T <sub>STG</sub>			- :	55 to +1	50			°C

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Measured at 1 MHz and Applied VR=4.0 Volts.

Note 3: Reverse Recovery Test Conditions:  $I_F$ =0.5A,  $I_R$ =1.0A,  $I_{RR}$ =0.25A



## **RS1AL - RS1ML**

Taiwan Semiconductor

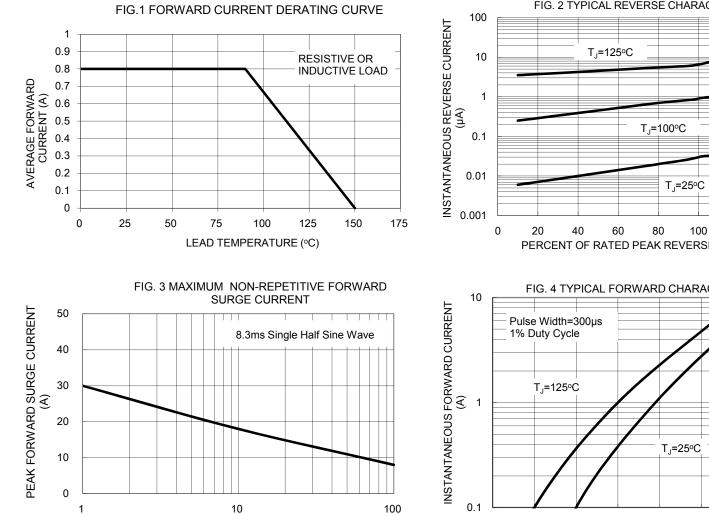
ORDERING	INFORMATIO	N			
PART NO.	PART NO.	PACKING CODE	PACKING CODE	PACKAGE	PACKING
	SUFFIX		SUFFIX		
		RU		Sub SMA	1,800 / 7" Plastic reel (8mm tape)
		RV		Sub SMA	3,000 / 7" Plastic reel (8mm tape)
		RT		Sub SMA	7,500 / 13" Paper reel (8mm tape)
		MT		Sub SMA	7,500 / 13" Plastic reel (8mm tape)
		RQ		Sub SMA	10,000 / 13" Paper reel (8mm tape)
RS1xL	RS1xL H (Note 1)	MQ	G	Sub SMA	10,000 / 13" Plastic reel (8mm tape)
(Note 1)		R3		Sub SMA	1,800 / 7" Plastic reel (12mm tape)
		RF		Sub SMA	3,000 / 7" Plastic reel (12mm tape)
		R2		Sub SMA	7,500 / 13" Paper reel (12mm tape)
		M2		Sub SMA	7,500 / 13" Plastic reel (12mm tape)
		RH		Sub SMA	10,000 / 13" Paper reel (12mm tape)
		MH		Sub SMA	10,000 / 13" Plastic reel (12mm tape)

Note 1: "x" defines voltage from 50V (RS1AL) to 1000V (RS1ML)

EXAMPLE					
PREFERRED PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
RS1MLHRUG	RS1ML	н	RU	G	AEC-Q101 qualified Green compound

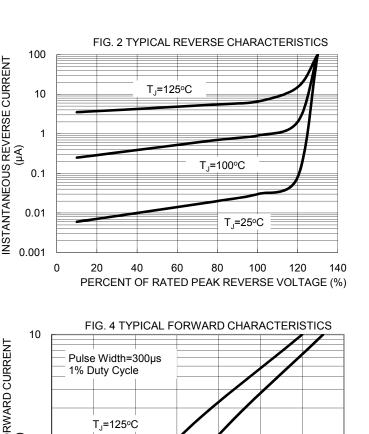
## **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub>=25°C unless otherwise noted)



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NUMBER OF CYCLES AT 60 Hz



0.8 1 1.2 1. FORWARD VOLTAGE (V)

1.4

1.6

0.4

0.6

0.8

1.8



trr 🔸

+0.5A

0

-0.25A

#### FIG. 5 TYPICAL JUNCTION CAPACITANCE



(-)

(+)

PULSE GENERATOR (NOTE 2)

10Ω NONINDUCTIVE

6 

OSCILLOSCOPE

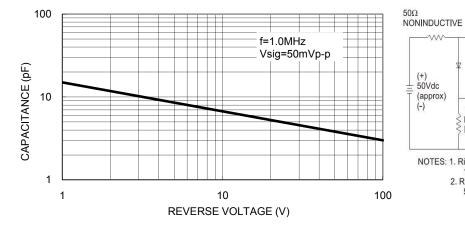
(NOTE 1)

w

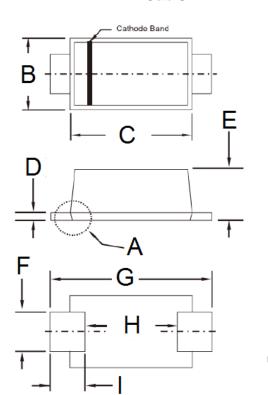
(+) 50Vdc (approx) (-)

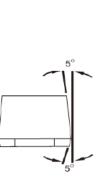
DUT

1Ω



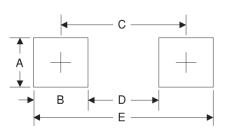
PACKAGE OUTLINE DIMENSIONS Sub SMA





DETAIL "A", SCALE=20/1

SUGG	iest	ED P	AD L	AYOL	IT



P/N

YW

G

F

Symbol	Unit (mm)	Unit (inch)
А	1.4	0.055
В	1.2	0.047
С	3.1	0.122
D	1.9	0.075
E	4.3	0.169

2.45

0.35

0.00

Н

I J

#### **MARKING DIAGRAM**



- = Marking Code
- = Green compound Code

= Date Code

= Factory Code

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NOTES: 1. Rise Time 1 megoh 2. Rise Time 50 ohms	m 22pf =10ns max. Sours	-		-1.0A	
	ЫМ	Unit	(mm)	Unit	(inch)
	DIM.	Unit ( Min	(mm) Max	Unit ( Min	(inch) Max
	DIM. B		. ,		,
		Min	Max	Min	Max
	В	<b>Min</b> 1.70	<b>Max</b> 1.90	<b>Min</b> 0.067	<b>Max</b> 0.075
	B C	Min 1.70 2.70	Max 1.90 2.90	<b>Min</b> 0.067 0.106	Max 0.075 0.114
	B C D	Min 1.70 2.70 0.16	Max           1.90           2.90           0.30	Min 0.067 0.106 0.006	Max 0.075 0.114 0.012

2.60

0.85

0.10

0.096

0.014

0.000

0.102

0.033

0.004



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